

# IRF7495

HEXFET® Power MOSFET

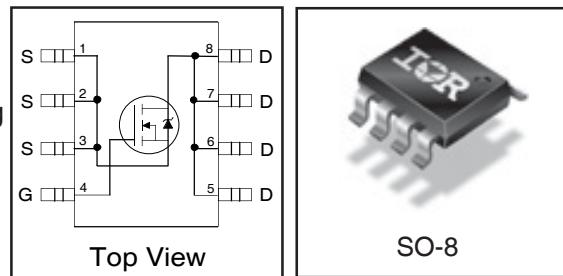
## Applications

- High frequency DC-DC converters

| <b>V<sub>DSS</sub></b> | <b>R<sub>DS(on)</sub> max</b>    | <b>I<sub>D</sub></b> |
|------------------------|----------------------------------|----------------------|
| <b>100V</b>            | <b>22mΩ@V<sub>GS</sub> = 10V</b> | <b>7.3A</b>          |

## Benefits

- Low Gate to Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective Coss to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current



## Absolute Maximum Ratings

|   | Parameter                                       | Max.         | Units |
|---|---|--------------|-------|
| V <sub>DS</sub>                         | Drain-to-Source Voltage                         | 100          | V     |
| V <sub>GS</sub>                         | Gate-to-Source Voltage                          | ± 20         |       |
| I <sub>D</sub> @ T <sub>A</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V | 7.3          | A     |
| I <sub>D</sub> @ T <sub>A</sub> = 100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V | 4.6          |       |
| I <sub>DM</sub>                         | Pulsed Drain Current ①                          | 58           |       |
| P <sub>D</sub> @ T <sub>A</sub> = 25°C  | Maximum Power Dissipation                       | 2.5          | W     |
|   | Linear Derating Factor                          | 0.02         | W/°C  |
| dv/dt                                   | Peak Diode Recovery dv/dt ②                     | 7.3          | V/ns  |
| T <sub>J</sub>                          | Operating Junction and                          |              |       |
| T <sub>STG</sub>                        | Storage Temperature Range                       | -55 to + 150 | °C    |

## Thermal Resistance

|                   | Parameter                         | Typ. | Max. | Units |
|-------------------|-----------------------------------|------|------|-------|
| R <sub>0,UL</sub> | Junction-to-Drain Lead            | —    | 20   | °C/W  |
| R <sub>0,JA</sub> | Junction-to-Ambient (PCB Mount) ③ | —    | 50   |       |

Notes ① through ⑥ are on page 8

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**Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

|   | Parameter                            | Min. | Typ. | Max. | Units               | Conditions   |
|---|--------------------------------------|------|------|------|---------------------|--|
| $V_{(\text{BR})\text{DSS}}$                   | Drain-to-Source Breakdown Voltage    | 100  | —    | —    | V                   | $V_{\text{GS}} = 0\text{V}$ , $I_D = 250\mu\text{A}$                                   |
| $\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$ | Breakdown Voltage Temp. Coefficient  | —    | 0.10 | —    | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$                                   |
| $R_{\text{DS}(\text{on})}$                    | Static Drain-to-Source On-Resistance | —    | 18   | 22   | $\text{m}\Omega$    | $V_{\text{GS}} = 10\text{V}$ , $I_D = 4.4\text{A}$ ④                                   |
| $V_{\text{GS}(\text{th})}$                    | Gate Threshold Voltage               | 2.0  | —    | 4.0  | V                   | $V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250\mu\text{A}$                               |
| $I_{\text{DSS}}$                              | Drain-to-Source Leakage Current      | —    | —    | 20   | $\mu\text{A}$       | $V_{\text{DS}} = 100\text{V}$ , $V_{\text{GS}} = 0\text{V}$                            |
|   |                                      | —    | —    | 250  |                     | $V_{\text{DS}} = 80\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $T_J = 125^\circ\text{C}$ |
| $I_{\text{GSS}}$                              | Gate-to-Source Forward Leakage       | —    | —    | 200  | nA                  | $V_{\text{GS}} = 20\text{V}$   |
|   | Gate-to-Source Reverse Leakage       | —    | —    | -200 |                     | $V_{\text{GS}} = -20\text{V}$  |

**Dynamic @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

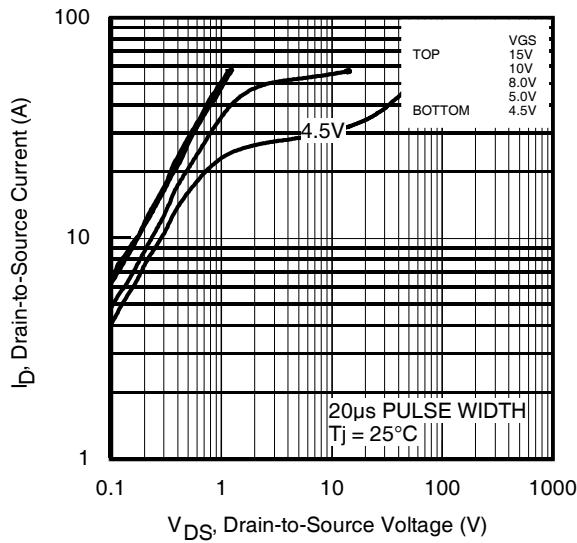
|                            | Parameter                       | Min. | Typ. | Max. | Units | Conditions  |
|----------------------------|---------------------------------|------|------|------|-------|---|
| $g_{\text{fs}}$            | Forward Transconductance        | 11   | —    | —    | S     | $V_{\text{DS}} = 25\text{V}$ , $I_D = 4.4\text{A}$                                |
| $Q_g$                      | Total Gate Charge               | —    | 34   | 51   |       | $I_D = 4.4\text{A}$   |
| $Q_{\text{gs}}$            | Gate-to-Source Charge           | —    | 6.3  | —    | nC    | $V_{\text{DS}} = 50\text{V}$  |
| $Q_{\text{gd}}$            | Gate-to-Drain ("Miller") Charge | —    | 11.7 | —    |       | $V_{\text{GS}} = 10\text{V}$ ④  |
| $t_{\text{d}(\text{on})}$  | Turn-On Delay Time              | —    | 8.7  | —    |       | $V_{\text{DD}} = 50\text{V}$  |
| $t_r$                      | Rise Time                       | —    | 13   | —    |       | $I_D = 4.4\text{A}$   |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time             | —    | 10   | —    | ns    | $R_G = 6.2\Omega$   |
| $t_f$                      | Fall Time                       | —    | 36   | —    |       | $V_{\text{GS}} = 10\text{V}$ ④  |
| $C_{\text{iss}}$           | Input Capacitance               | —    | 1530 | —    |       | $V_{\text{GS}} = 0\text{V}$   |
| $C_{\text{oss}}$           | Output Capacitance              | —    | 250  | —    | pF    | $V_{\text{DS}} = 25\text{V}$  |
| $C_{\text{rss}}$           | Reverse Transfer Capacitance    | —    | 110  | —    |       | $f = 1.0\text{MHz}$   |
| $C_{\text{oss}}$           | Output Capacitance              | —    | 980  | —    |       | $V_{\text{GS}} = 0\text{V}$ , $V_{\text{DS}} = 1.0\text{V}$ , $f = 1.0\text{MHz}$ |
| $C_{\text{oss}}$           | Output Capacitance              | —    | 160  | —    |       | $V_{\text{GS}} = 0\text{V}$ , $V_{\text{DS}} = 80\text{V}$ , $f = 1.0\text{MHz}$  |
| $C_{\text{oss eff.}}$      | Effective Output Capacitance    | —    | 240  | —    |       | $V_{\text{GS}} = 0\text{V}$ , $V_{\text{DS}} = 0\text{V}$ to $80\text{V}$ ⑤       |

## Avalanche Characteristics

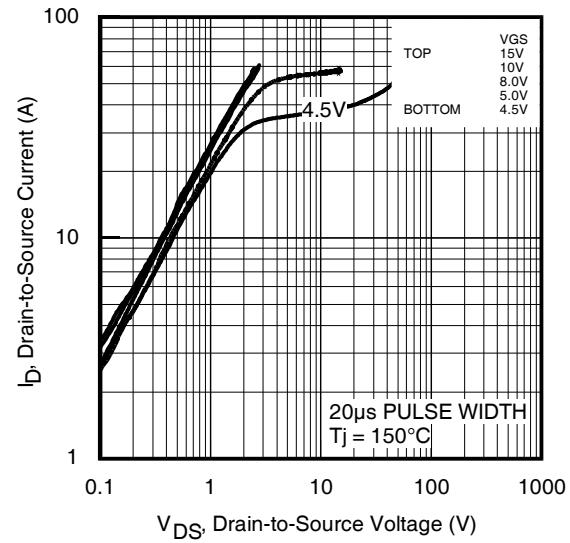
|                 | Parameter                       | Typ. | Max. | Units |
|-----------------|---------------------------------|------|------|-------|
| $E_{\text{AS}}$ | Single Pulse Avalanche Energy ② | —    | 180  | mJ    |
| $I_{\text{AR}}$ | Avalanche Current ①             | —    | 4.4  | A     |

## Diode Characteristics

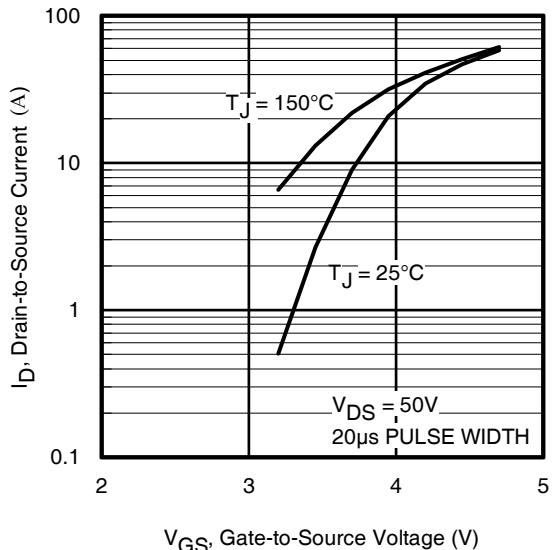
|                 | Parameter                              | Min.   | Typ. | Max. | Units | Conditions   |
|-----------------|--|--|------|------|-------|--|
| $I_S$           | Continuous Source Current (Body Diode) | —  | —    | 2.3  |       | MOSFET symbol showing the integral reverse p-n junction diode.                 |
| $I_{\text{SM}}$ | Pulsed Source Current (Body Diode) ①   | —  | —    | 58   | A     |  |
| $V_{\text{SD}}$ | Diode Forward Voltage                  | —  | —    | 1.3  | V     | $T_J = 25^\circ\text{C}$ , $I_S = 4.4\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ④ |
| $t_{\text{rr}}$ | Reverse Recovery Time                  | —  | 42   | —    | ns    | $T_J = 25^\circ\text{C}$ , $I_F = 4.4\text{A}$ , $V_{\text{DD}} = 25\text{V}$  |
| $Q_{\text{rr}}$ | Reverse Recovery Charge                | —  | 73   | —    | nC    | $dI/dt = 100\text{A}/\mu\text{s}$ ④  |
| $t_{\text{on}}$ | Forward Turn-On Time                   | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) |      |      |       |  |



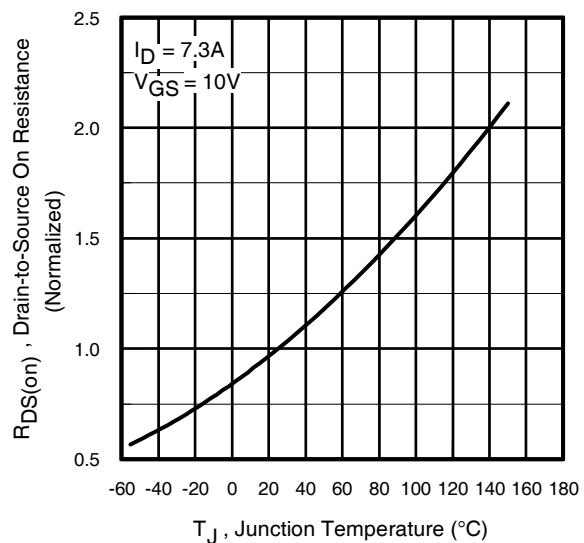
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



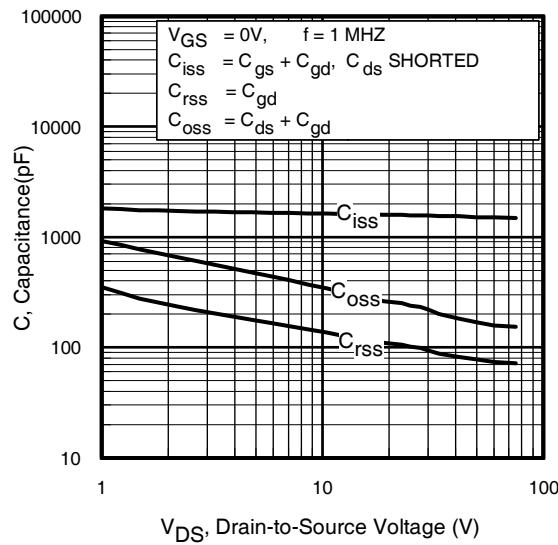
**Fig 3.** Typical Transfer Characteristics



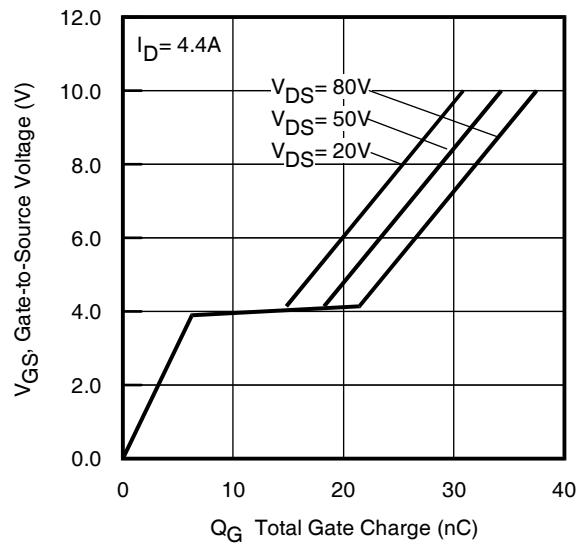
**Fig 4.** Normalized On-Resistance  
vs. Temperature

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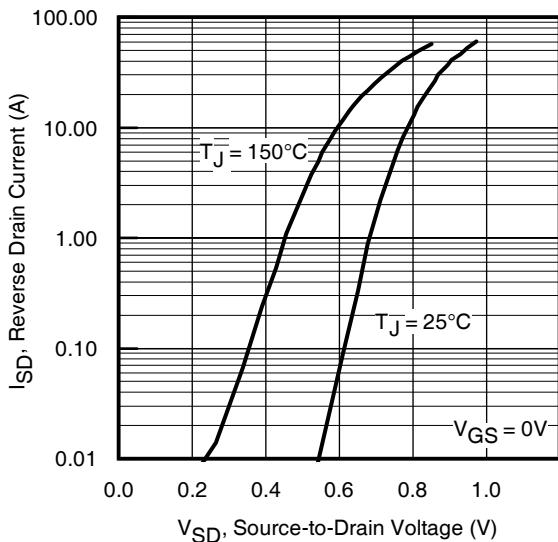
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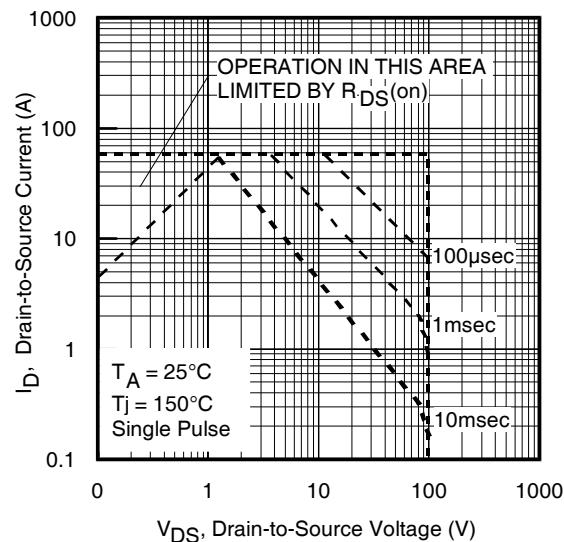
**Fig 5.** Typical Capacitance vs.  
Drain-to-Source Voltage



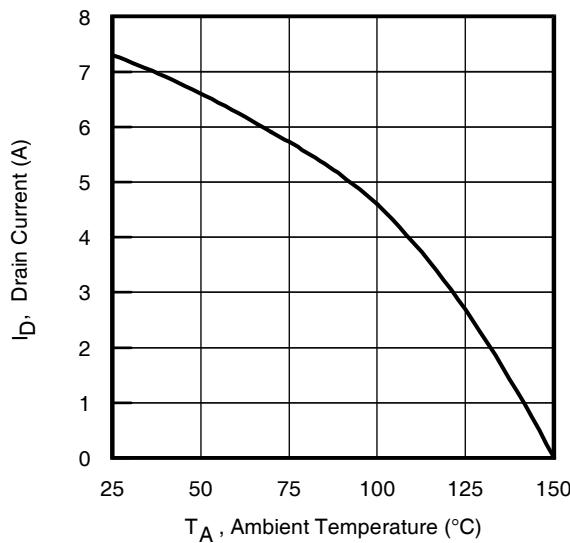
**Fig 6.** Typical Gate Charge vs.  
Gate-to-Source Voltage



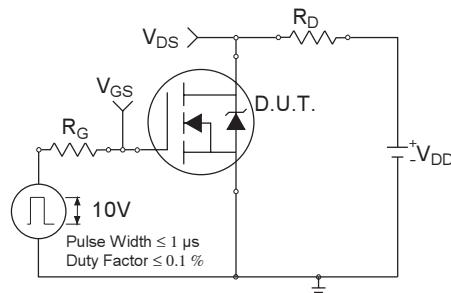
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



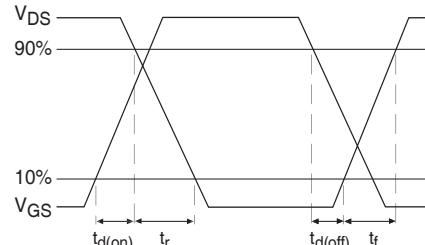
**Fig 8.** Maximum Safe Operating Area



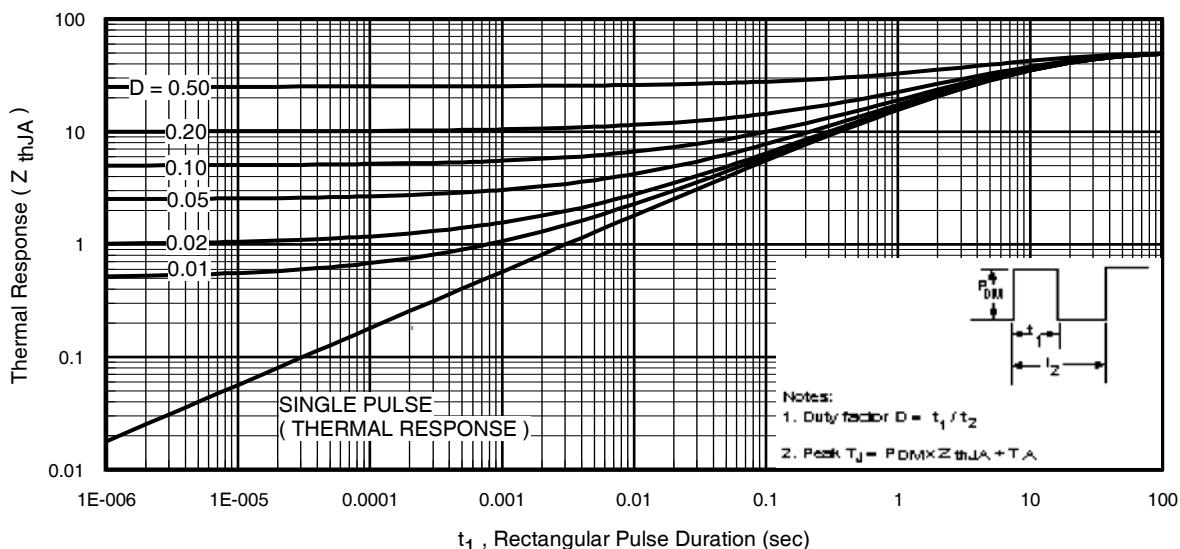
**Fig 9.** Maximum Drain Current vs.  
Ambient Temperature



**Fig 10a.** Switching Time Test Circuit



**Fig 10b.** Switching Time Waveforms



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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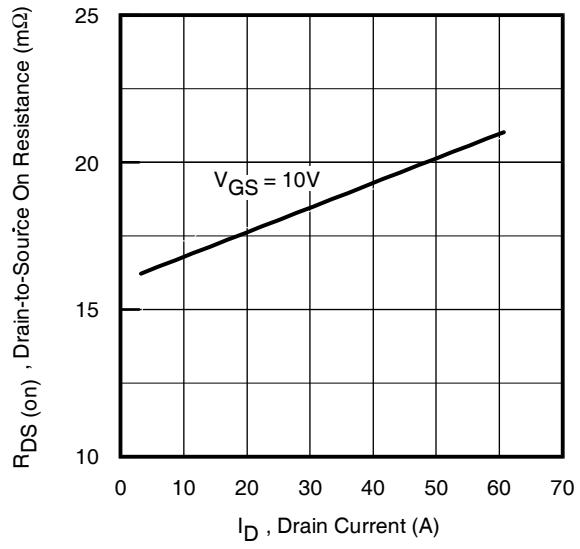


Fig 12. On-Resistance vs. Drain Current

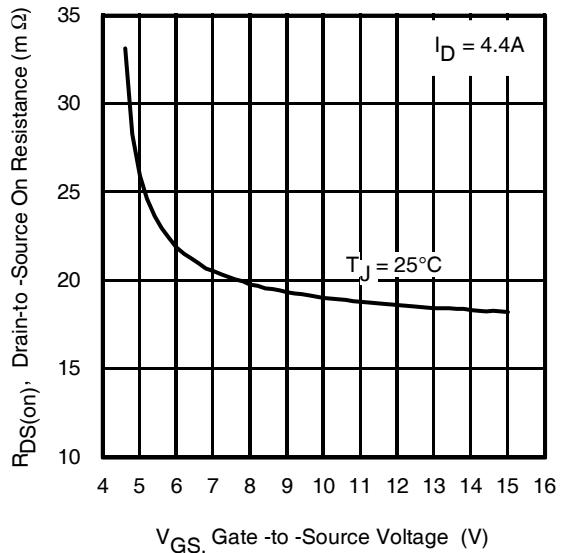


Fig 13. On-Resistance vs. Gate Voltage

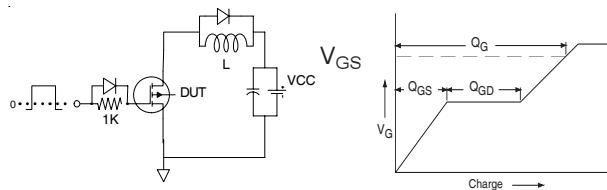


Fig 14a&b. Basic Gate Charge Test Circuit and Waveform

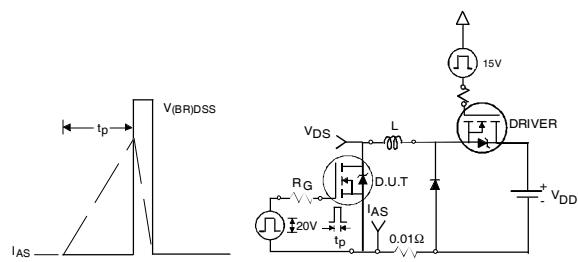


Fig 15a&b. Unclamped Inductive Test circuit and Waveforms

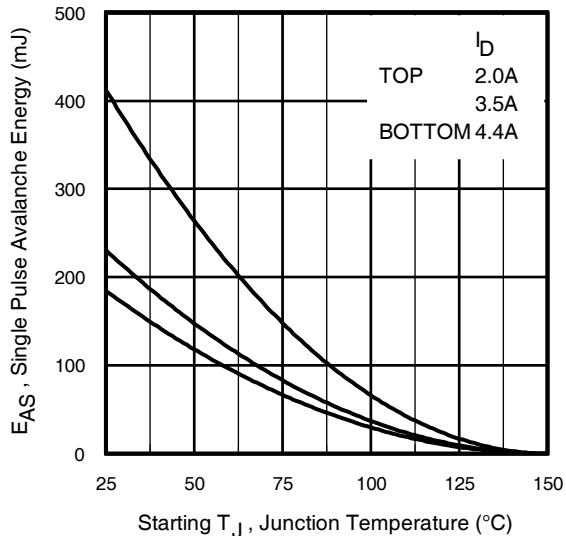


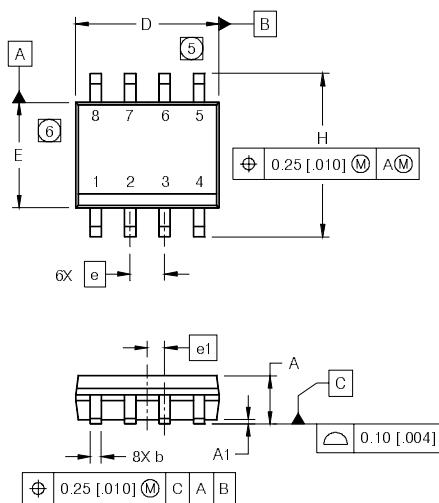
Fig 15c. Maximum Avalanche Energy vs. Drain Current

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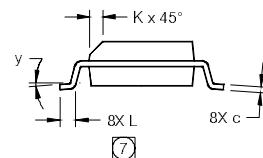
**IRF7495**

## SO-8 Package Outline

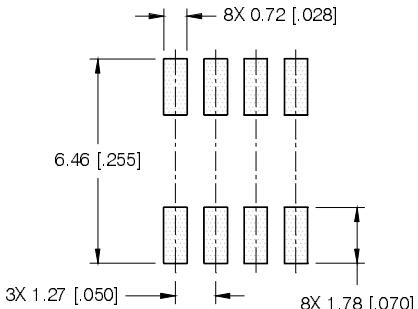
Dimensions are shown in millimeters (inches)



| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | .0532  | .0688 | 1.35        | 1.75  |
| A1  | .0040  | .0098 | 0.10        | 0.25  |
| b   | .013   | .020  | 0.33        | 0.51  |
| c   | .0075  | .0098 | 0.19        | 0.25  |
| D   | .189   | .1968 | 4.80        | 5.00  |
| E   | .1497  | .1574 | 3.80        | 4.00  |
| e   | .050   | BASIC | 1.27        | BASIC |
| e1  | .025   | BASIC | 0.635       | BASIC |
| H   | .2284  | .2440 | 5.80        | 6.20  |
| K   | .0099  | .0196 | 0.25        | 0.50  |
| L   | .016   | .050  | 0.40        | 1.27  |
| y   | 0°     | 8°    | 0°          | 8°    |

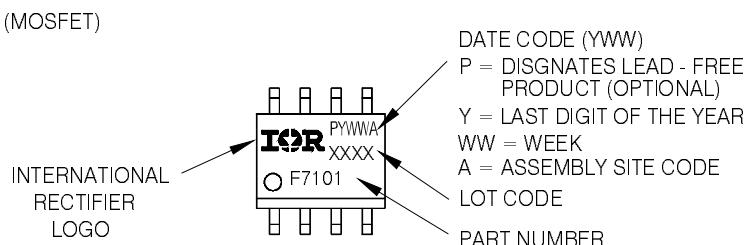


### FOOTPRINT



## SO-8 Part Marking Information

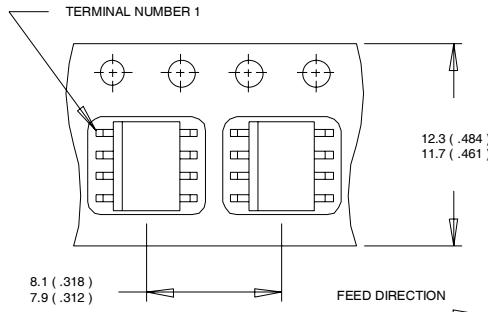
EXAMPLE: THIS IS AN IRF7101 (MOSFET)



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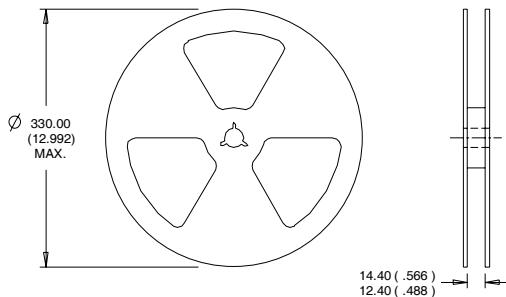
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## SO-8 Tape and Reel



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 19\text{mH}$   
 $R_G = 25\Omega$ ,  $I_{AS} = 4.4\text{A}$ .
- ③ When mounted on 1 inch square copper board,  $t \leq 10$  sec.
- ④ Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ⑤  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ⑥  $I_{SD} \leq 5.8\text{A}$ ,  $di/dt \leq 250\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ\text{C}$ .

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Industrial market.  
Qualification Standards can be found on IR's Web site.

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